

## Electronic Patent Application Fee Transmittal

<b>Application Number:</b>	10661974				
<b>Filing Date:</b>	11-Sep-2003				
<b>Title of Invention:</b>	Systems and methods for fabricating microstructures by imaging a radiation sensitive layer sandwiched between outer layers, and microstructures fabricated thereby				
<b>First Named Inventor:</b>	Robert L. Wood				
<b>Filer:</b>	Mitchell S. Bigel/Susan Freedman				
<b>Attorney Docket Number:</b>	9409-4				
Filed as Small Entity					
<b>Utility Filing Fees</b>					
<b>Description</b>		<b>Fee Code</b>	<b>Quantity</b>	<b>Amount</b>	<b>Sub-Total in USD(\$)</b>
<b>Basic Filing:</b>					
<b>Pages:</b>					
<b>Claims:</b>					
<b>Miscellaneous-Filing:</b>					
<b>Petition:</b>					
<b>Patent-Appeals-and-Interference:</b>					
<b>Post-Allowance-and-Post-Issuance:</b>					
<b>Extension-of-Time:</b>					

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
<b>Miscellaneous:</b>				
Submission- Information Disclosure Stmt	1806	1	180	180
<b>Total in USD (\$)</b>				<b>180</b>